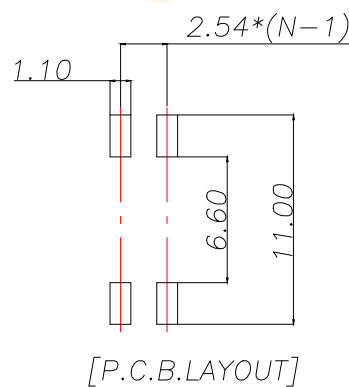
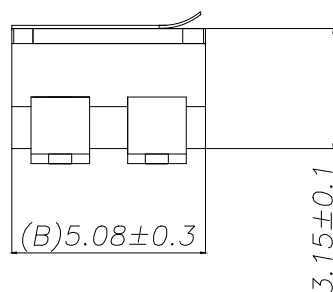
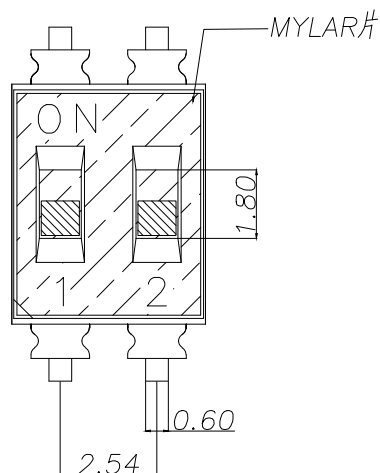


[Schematic]

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

NOTES:

1.Specification:

- 1>.Operation force: 1000gf Max.
- 2>.Operation Temperature: -30° to $+85^{\circ}$.
- 3>.Storage Temperature: -40° to $+85^{\circ}$.
- 4>.Mechanical Life: 3000 cycles operations.
- 5>.Resistance to Soldering: $260\pm 5^{\circ}$ for 3-5 Seconds.

2.PLATING:

- 1>.GOLD flash 1u"(min) SOLDER TAIL,
3u" GOLD PLATING ON THE CONTACT AREA.

3.ELECTRICAL:

- 1>.Non-switch Rating: 100mA at 50V DC.
- 2>.Switching Rating: 25mA at 24V DC.
- 3>.Contact Resistance: Initial 50m Ω Max.
Contact Resistance: After life 100m Ω Max.
- 4>.Insulation Resistance: 100M Ω Min at 500VDC.
- 5>.Dielectric Strength: 500V AC for 60seconds.
- 6>.Switch Capacitance: 5PF Max at 1MHZ.

4.PART NUMBER DESCRIPTION:

DSIC XX I S G E R

